

Count	RefDes	Value	description	Size	Part Number	MFR
2	C10-11	1uF	Capacitor, Ceramic Chip, 10V, ±10%	603	C1608X5R1A105K	TDK
2	J1 J3	690-004-261-013	Connector, USB-A, Right Angle, Vertical	7.5mm x 14.0 mm	690-004-261-013	EDAC
4	R21 R23 R26 R28	100k	Resistor, Chip, 1/16W, 1%	603	STD	STD
2	R19 R24	22.1k	Resistor, Chip, 1/16W, 1%	603	STD	STD
2	R20 R25	48.7k	Resistor, Chip, 1/16W, 1%	603	STD	STD
1	TP5	5000	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100 inch	5000	Keystone
1	TP6	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
2	U3-4	TPS2543RTE	IC, USB Charging Port Power Switch & Controller with Load Detect Feature.	QFN-16	TPS2543RTE	TI

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